



AF/1 PW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Norihiro TSUKAHARA et al.

Serial No. 10/736,568

Filed December 17, 2003

SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURING METHOD AND
SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURED BY THE METHOD

: Confirmation No. 4502

: Attorney Docket No. 2003_1827

: Group Art Unit 2891

Corres. and Mail

BOX AF

: Examiner Caridad Everhart

: Mail Stop: AF

**RESPONSE UNDER 37. CFR 1.116
EXPEDITED PROCEDURE**

EXAMINING GROUP

a891

AMENDMENT AFTER FINAL

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action of January 11, 2006, please amend the above-referenced U.S. patent application as follows: